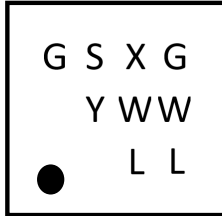


Dual N-channel Power MOSFET:  
22V, 18mohm, 6.7A

Product Summary				
VSSS	VGSS	RSS(ON) TYP/MAX		IS MAX
22V	± 12V	18.0/23.5	mΩ@VGS=4.5V	6.7A
		19.0/25.0	mΩ@VGS=3.8V	
		20.5/33.5	mΩ@VGS=3.1V	
		24.5/50.0	mΩ@VGS=2.5V	

### Marking Symbol Code

❖ Laser Marking Device Code: X



GS : Gostone (fixed)  
X : Marking Device Code (fixed)  
G : Factory Code (fixed)  
Y : Year Code  
W : Week Code  
L : LOT Code  
● : Pin#1 Identifier

### Form

❖ Tape & Reel Embossed Type: 5,000pcs / reel

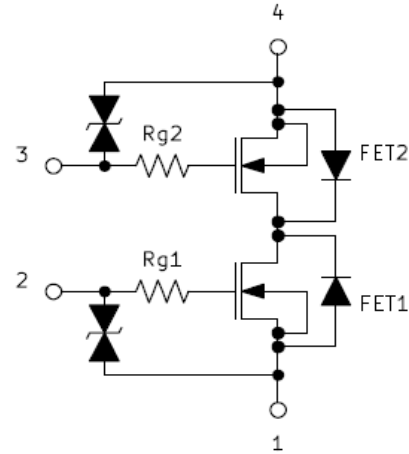
### Features

- ❖ CSP (Chip Size Package)
- ❖ Halogen-Free / RoHS Compliant
- ❖ 2.5V Drive Low Source-Source On-State Resistance
- ❖ Gate Resistor Installed Common-Drain Type MOSFET
- ❖ ESD Protection Diode Installed (Gate-Source)

### Application

- ❖ Lithium-Ion Secondary Battery Protection Circuits

### Equivalent circuit



Absolute Maximum Rating Ta=25°C				
Parameter	Symbol	Rating	Unit	
Source to Source Voltage	VSS	22	V	
Gate to Source Voltage	VGS	±12	V	
Source Current	DC	IS1 <sup>*1</sup>	4.1	A
	DC	IS2 <sup>*2</sup>	6.7	A
	Pulse	ISP <sup>*2*3</sup>	27	A
Total Dissipation	DC	PD1 <sup>*1</sup>	0.39	W
	DC	PD2 <sup>*2</sup>	1.14	W
Junction Temperature	Tj	150	°C	
Storage Temperature	Tstg	-55 to +150	°C	

Thermal Characteristics Ta = 25°C			
Parameter	Symbol	Rating	Unit
Thermal Resistance	Rth <sup>*1</sup>	318	°C/W
	Rth <sup>*2</sup>	110	°C/W

Note \*1 Mounted on FR4 board (25.4mm x 25.4mm x t1.0mm)

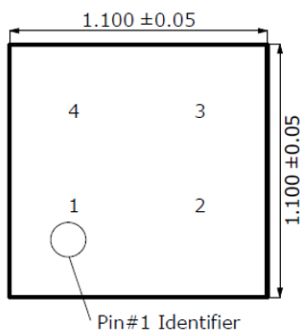
with minimum copper pad (44.6mm<sup>2</sup>, 36μm thickness copper)

Note \*2 Mounted on FR4 board (25.4mm x 25.4mm x t1.0mm)

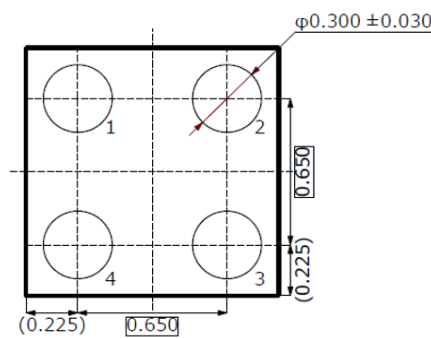
with maximum copper pad (617.5mm<sup>2</sup>, 36μm thickness copper)

Note \*3 t=10μs, duty cycle ≤ 1%

### TOP View



### Bottom View



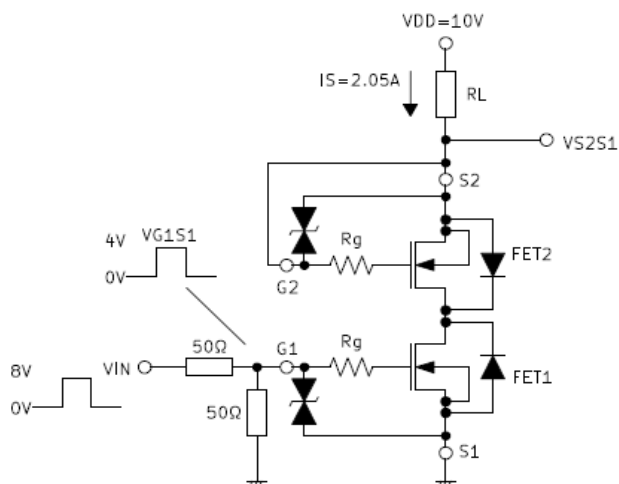
1: Source1(FET1) 2: Gate1  
4: Source2(FET2) 3: Gate2

**Electrical Characteristics (Ta=25degC +/- 3degC)**

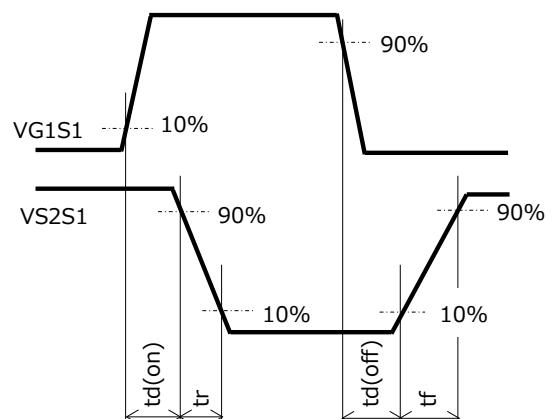
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Source-Source Breakdown Voltage	VSSS	IS=1mA, VGS=0V	22			V
Zero Gate Voltage Source Current	ISSS	VSS=22V, VGS=0V			1.0	μA
Gate-Source Leakage Current	IGSS	VGS=±8V, VSS=0V			±10.0	μA
Gate-Source Threshold Voltage	Vth	VSS=10V, IS=1.0mA	0.35	0.9	1.4	V
Source-Source On-State Resistance	RSS(on)1	IS=2.05A, VGS=4.5V	12.0	18.0	23.5	mΩ
	RSS(on)2	IS=2.05A, VGS=3.8V	12.5	19.0	25.0	
	RSS(on)3	IS=2.05A, VGS=3.1V	13.0	20.5	33.5	
	RSS(on)4	IS=2.05A, VGS=2.5V	14.5	24.5	50.0	
Body Diode Forward Voltage	VF(S-S)	IF=2.05A, VGS=0V		0.7	1.0	V
Input Capacitance <sup>*1</sup>	Ciss	VSS=10V, VGS=0V, f=1kHz		486		pF
Output Capacitance <sup>*1</sup>	Coss			78		
Reverse Transfer Capacitance <sup>*1</sup>	Crss			64		
Turn-On Delay Time <sup>*1 *2</sup>	td(on)	VDD=10V, VGS=0 to 4.0V, IS=2.05A		13		μs
Rise Time <sup>*1 *2</sup>	tr			41		
Turn-Off Delay Time <sup>*1 *2</sup>	td(off)	VDD=10V, VGS=4.0 to 0V, IS=2.05A		128		μs
Fall Time <sup>*1 *2</sup>	tf			50		
Total Gate Charge <sup>*1</sup>	Qg	VDD=10V, VGS=0 to 4.0V, IS=4.1A		8.5		nC
Gate-Source Charge <sup>*1</sup>	Qgs			0.8		
Gate-Drain Charge <sup>*1</sup>	Qgd			2.8		
Gate Resistance <sup>*1</sup>	Rg	f=1MHz		32		Ω

Note \*1 Guaranteed by Design

Note \*2 Measurement Circuit for Switching Characteristics

**FET1 Measurement Circuit for Switching Characteristics td(on), tr, td(off), tf (FET2: Gate-Source Short)**


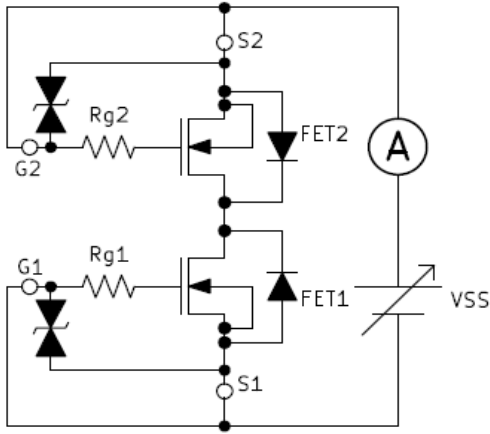
(Definition of Switching Measurement Detection)



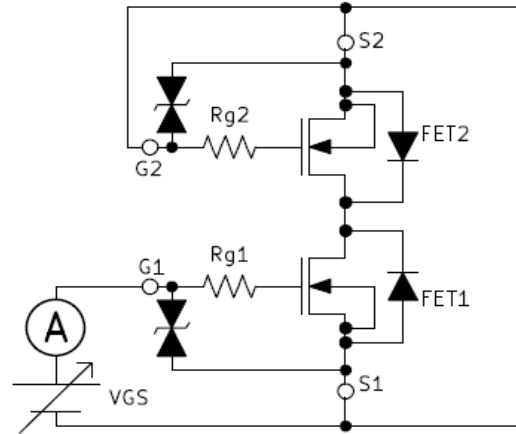


Test circuits for FET1

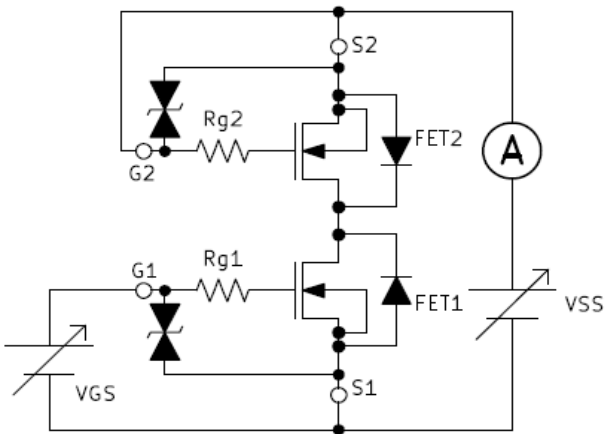
Test Circuit 1  
VSSS/ISSS



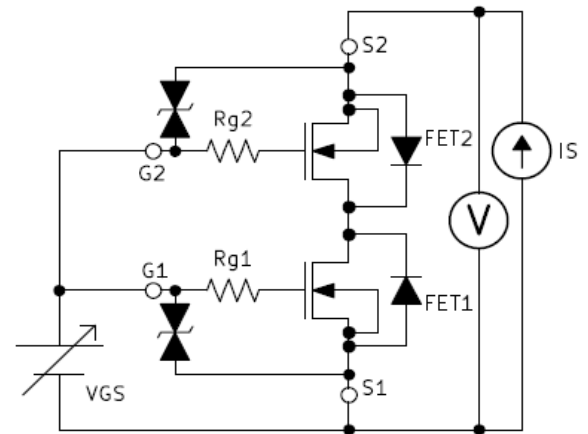
Test Circuit 2  
IGSS1/2



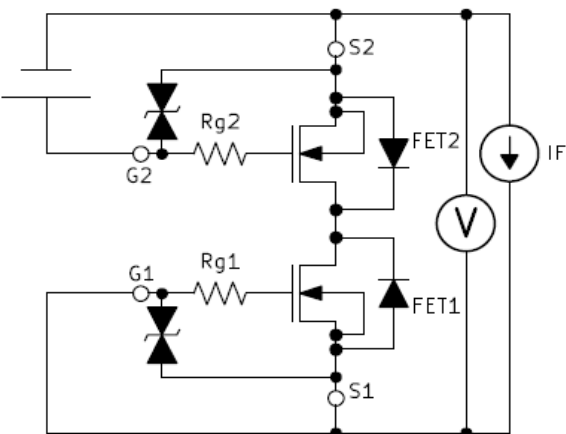
Test Circuit 3  
Vth



Test Circuit 4  
RSS(on)



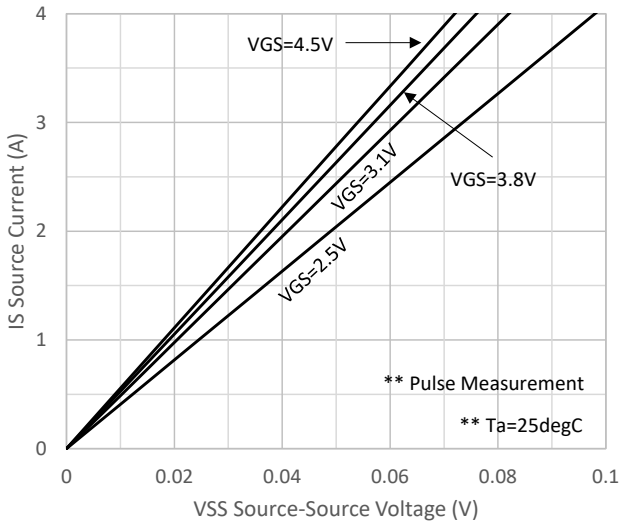
Test Circuit 5  
VF(S-S)



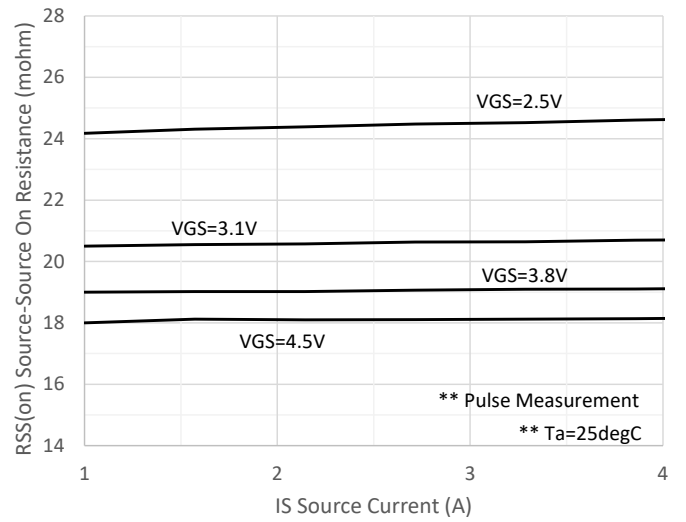


Technical data

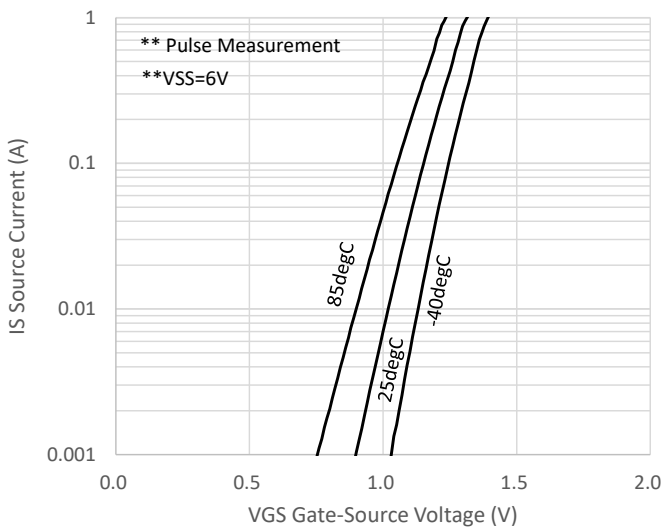
IS to VSS



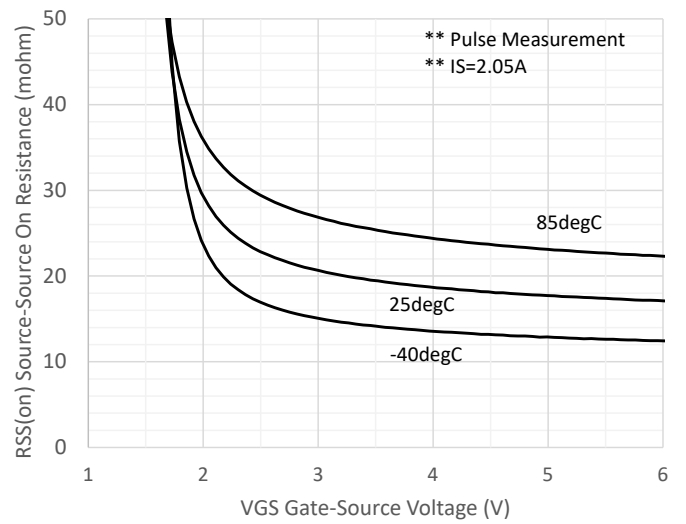
RSS(on) to IS



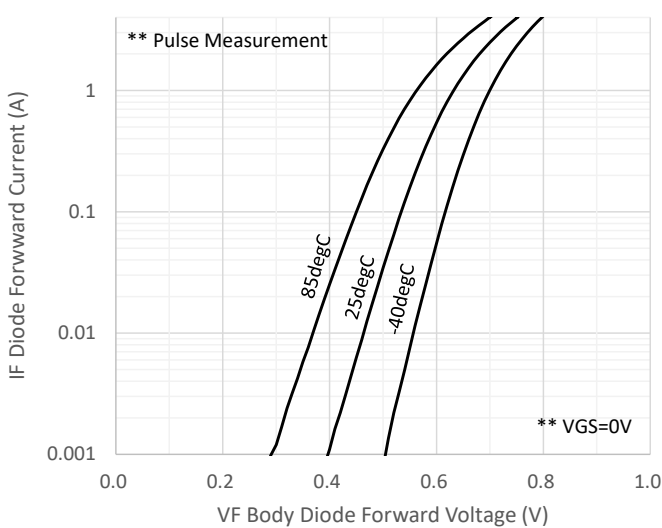
IS to VGS



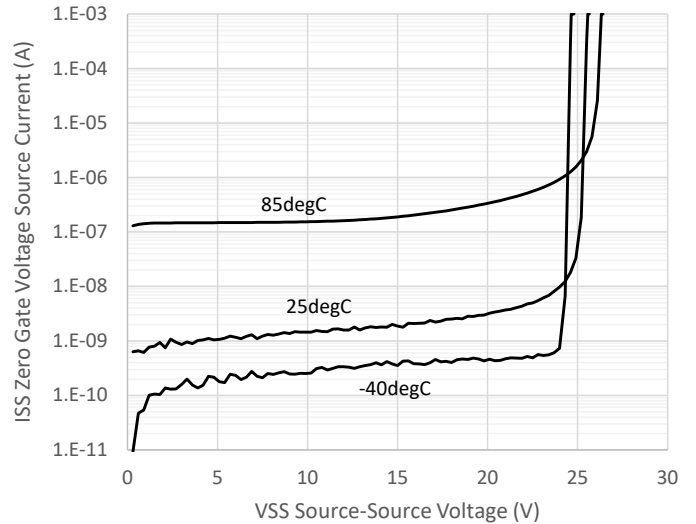
RSS(on) to VGS



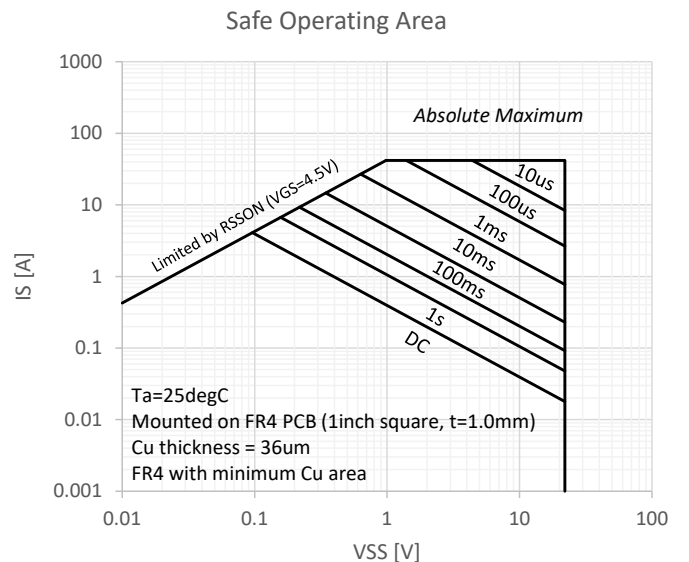
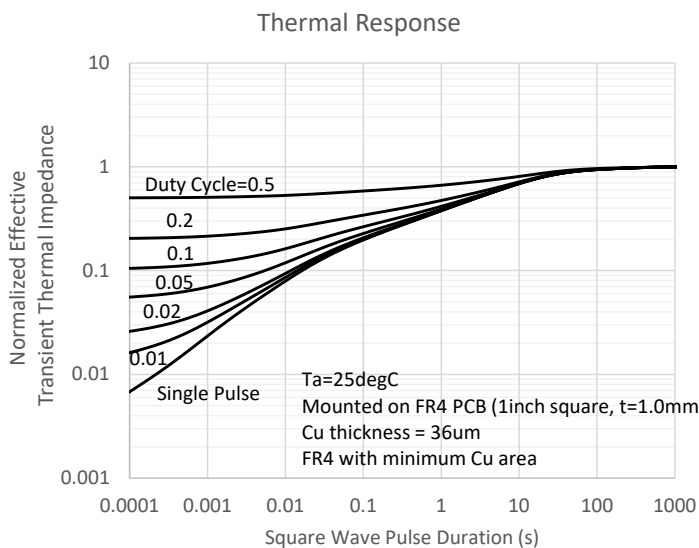
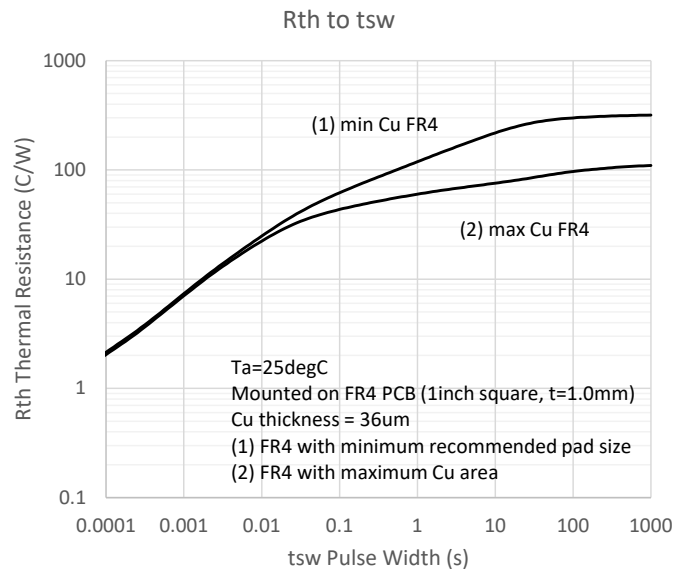
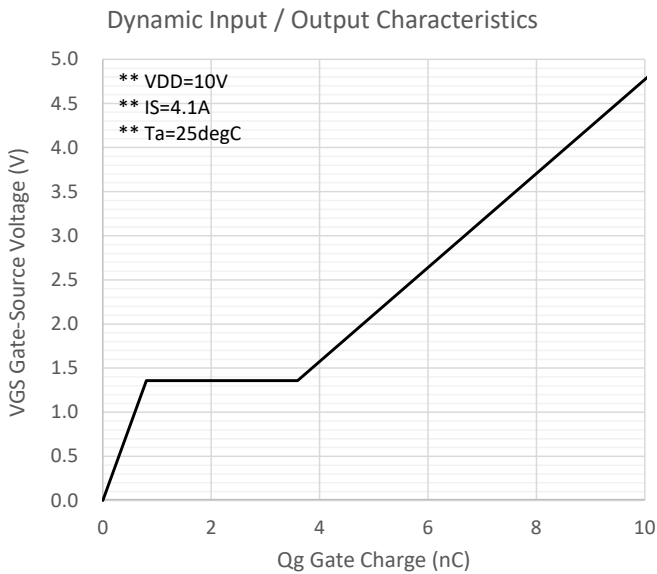
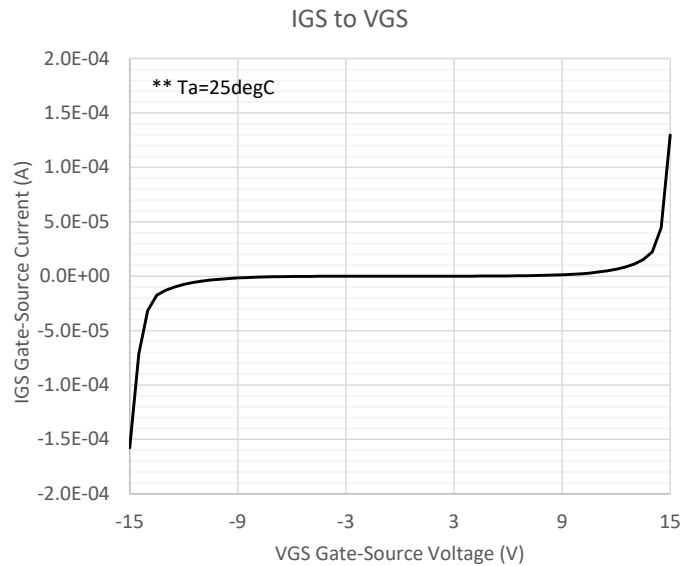
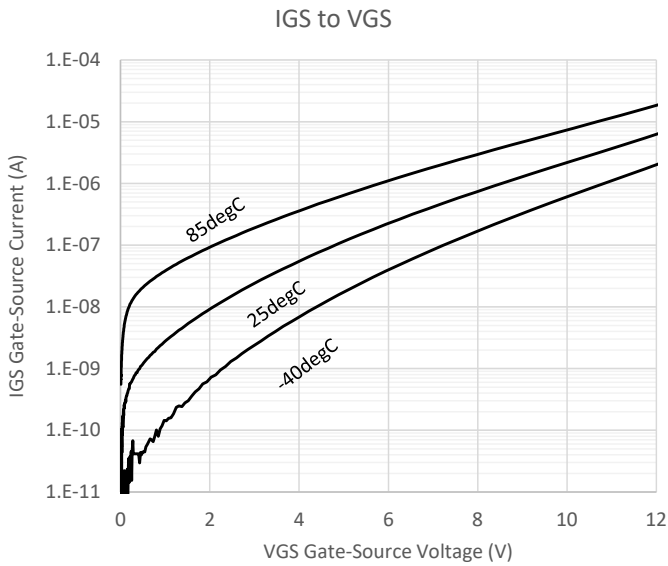
IF to VF



ISS to VSS

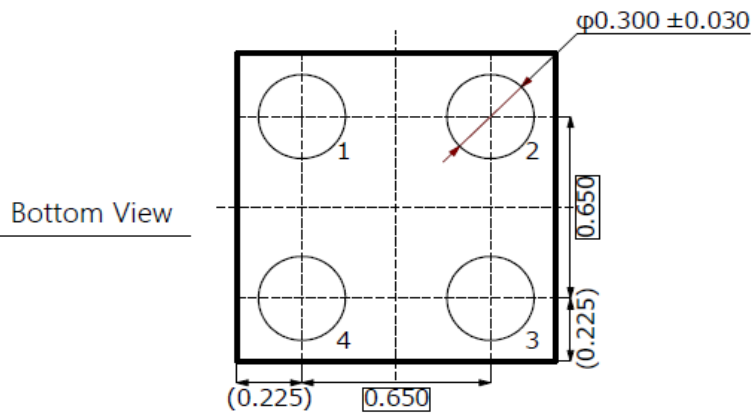
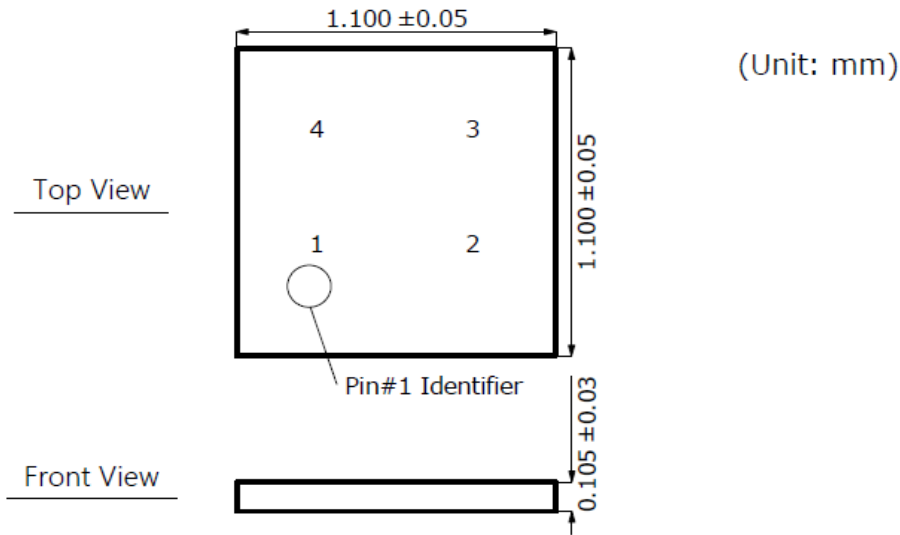


Technical data

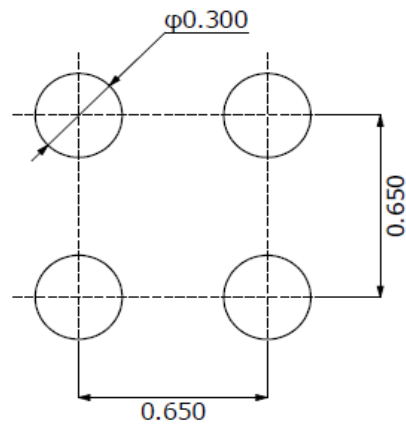




Package Outline Dimensions



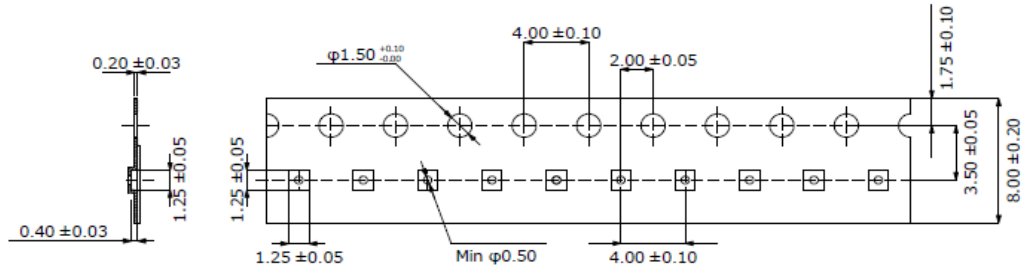
(Reference) Board Land and Stencil Mask Pattern (Unit: mm)



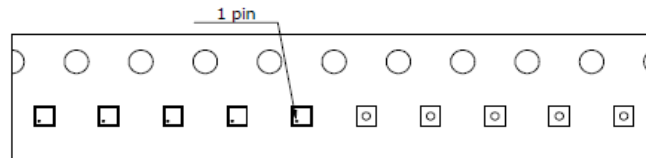
**Form**

- ❖ Tape & Reel Embossed Type: 5,000pcs / reel
- ❖ Factory PKG Code: WLCSP 1.1X1.1\_4
- ❖ Tape Width: 8mm, Pitch: 4mm, Reel Size: 7inch

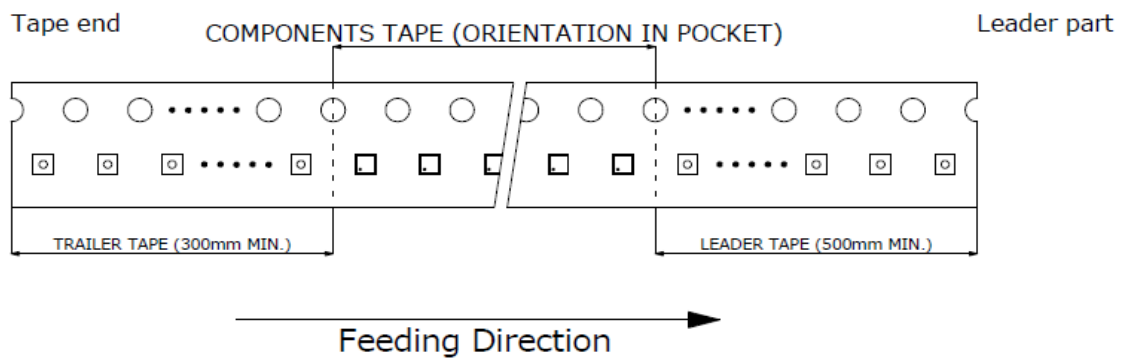
**Tape size (mm)**



**Pin1 Direction**



**Tape end ~ Leader part (mm)**



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